FIG. 1

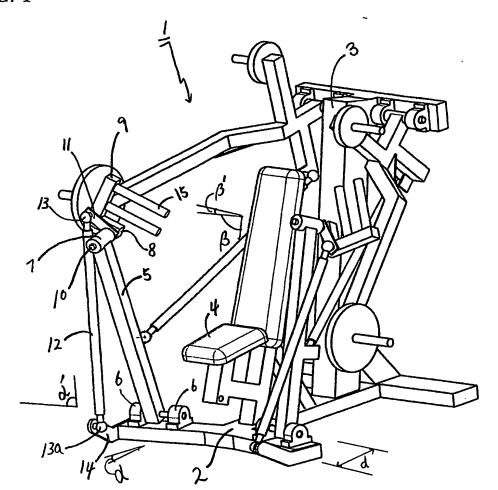


FIG. 2

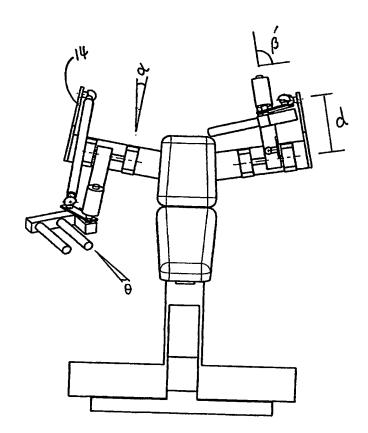
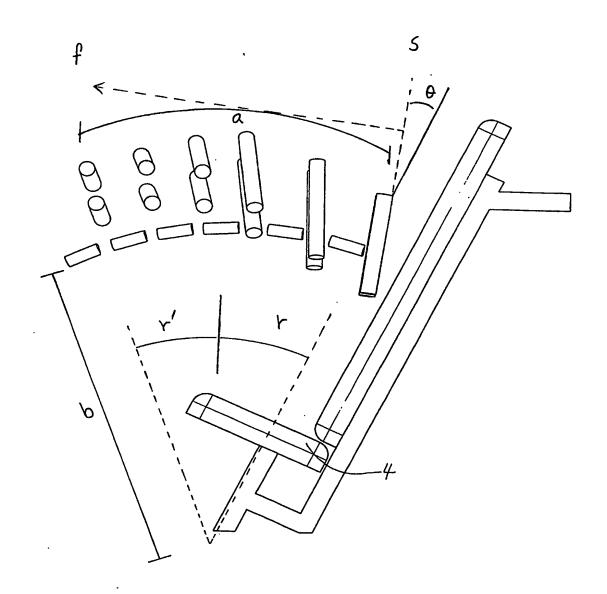


FIG. 3



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FIG. 4

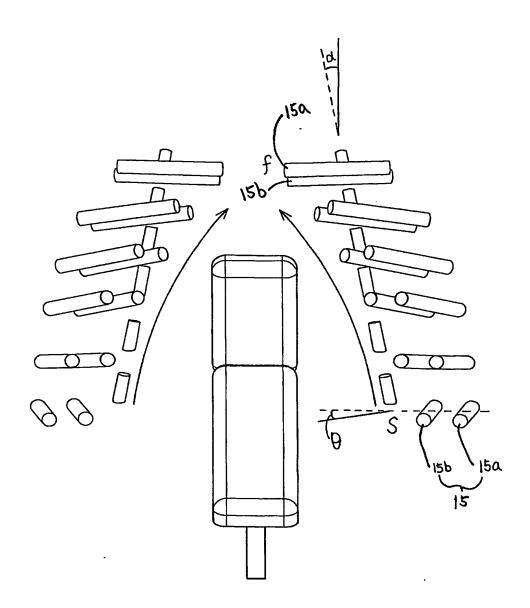


FIG. 5

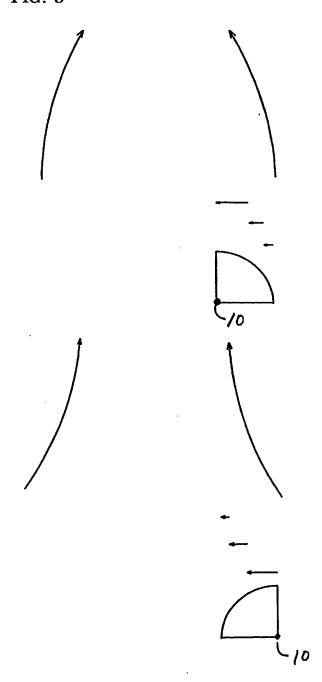
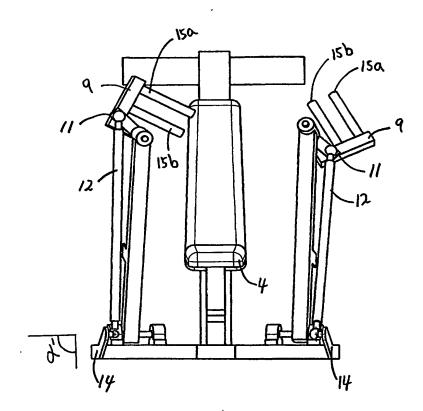
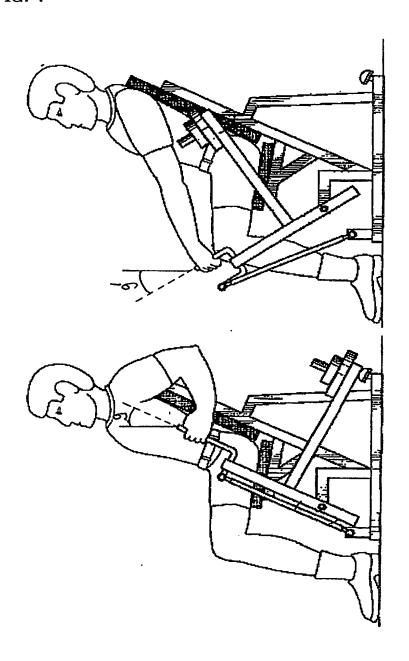


FIG. 6



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FIG. 7



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FIG. 8a

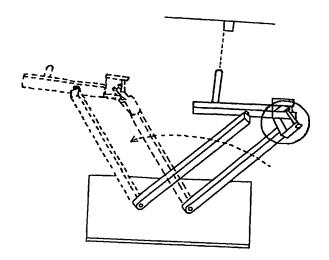


FIG. 8b

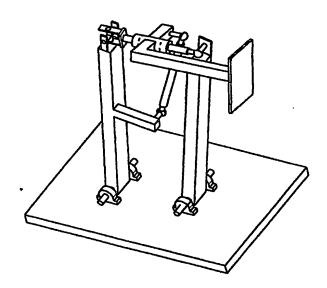


FIG. 9a

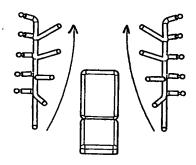


FIG. 9b

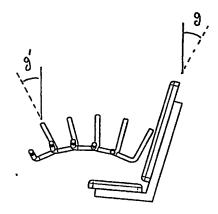


FIG. 10

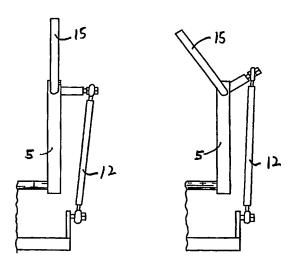


FIG. 11

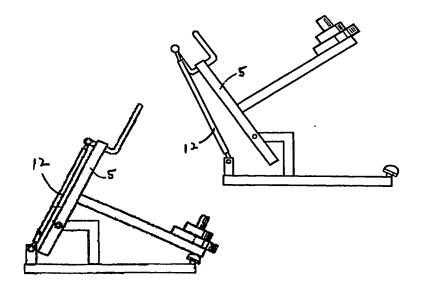


FIG. 12a

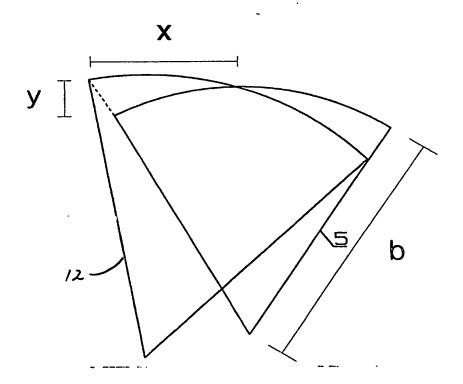


FIG. 12b

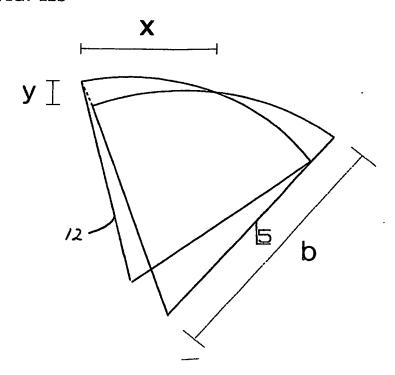


FIG. 13

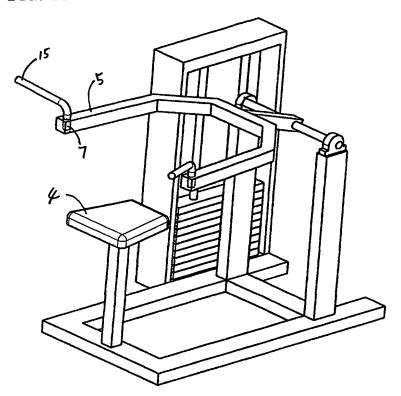


FIG. 14

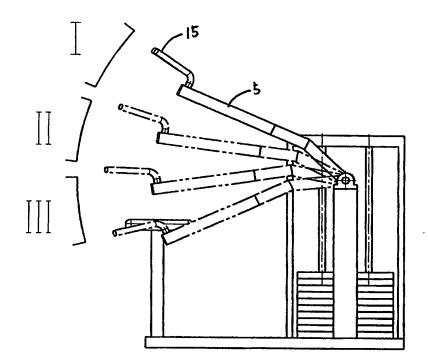


FIG. 15a

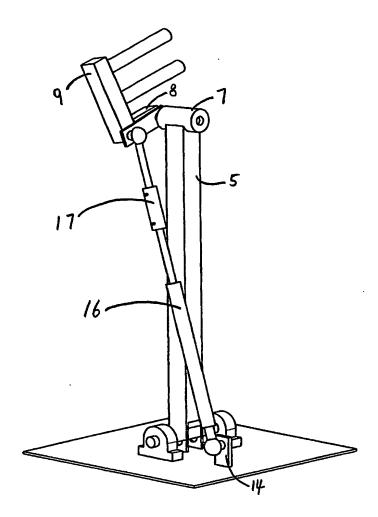


FIG. 15b

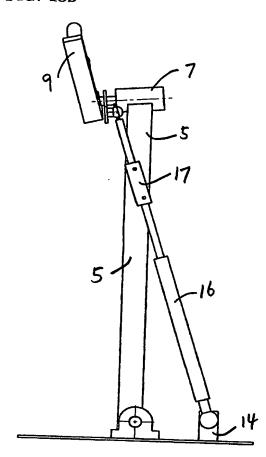
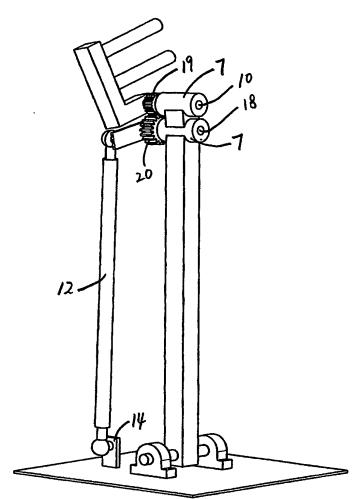


FIG. 16a



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FIG. 16b

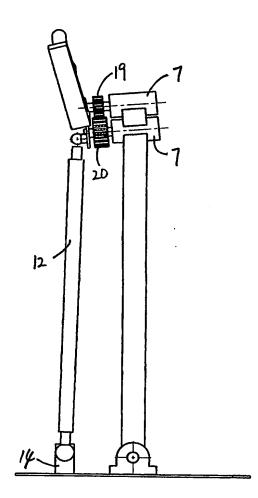


FIG. 17a

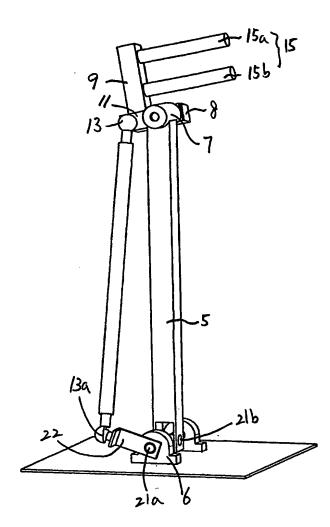


FIG. 17b

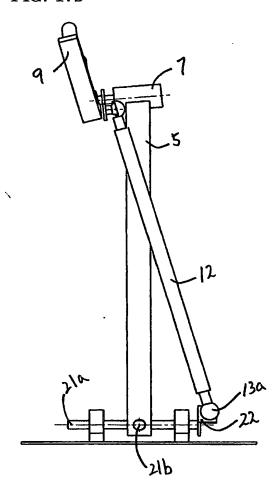
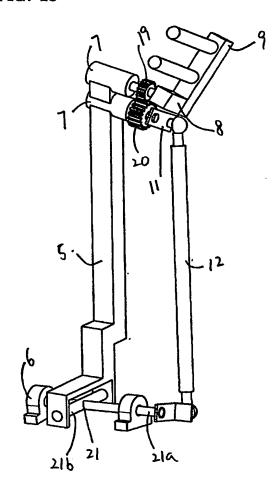


FIG. 18



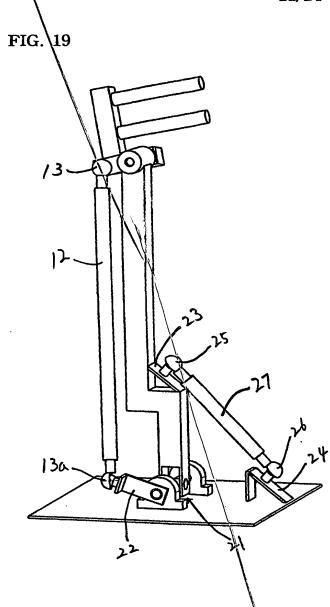


FIG. 20a

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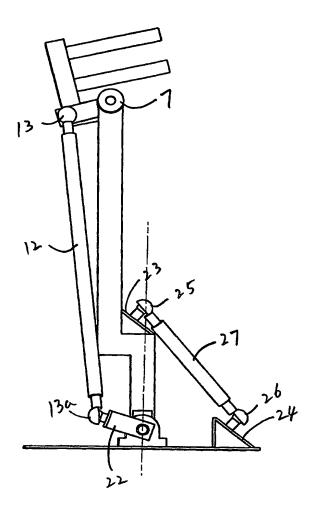


FIG. 20b

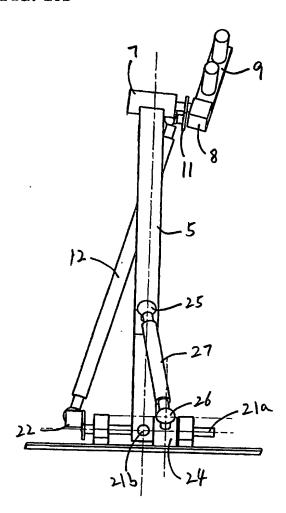
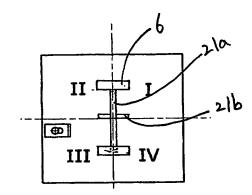


FIG. 21a



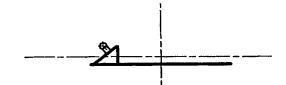


FIG. 21b

